## PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
KOICHI SHIBATA	07/07/2020
TEIZI SATOU	07/07/2020
DAISUKE INOKI	07/07/2020
HIDEKI HAYASHI	07/07/2020

## **RECEIVING PARTY DATA**

Name:	JNC CORPORATION
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City:	TOKYO
State/Country:	JAPAN
Postal Code:	1008105

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16968874

### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER: 084983-US-1002-PCT NAME OF SUBMITTER: **BELINDA LEE SIGNATURE:** /Belinda Lee/ 08/14/2020 **DATE SIGNED:** 

**Total Attachments: 2** 

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> **PATENT** REEL: 053492 FRAME: 0884 506203393

CS6348US 084983-US-1002-PCT

# **ASSIGNMENT**

WHEREAS,

1. Koichi SHIBATA

2. Teizi SATOU

3. Daisuke INOKI

4. Hideki HAYASHI

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: POLYMERIZABLE COMPOUND, POLYMERIZABLE COMPOSITION, POLYMER, AND PHOTORESIST COMPOSITION

[x] Filed:

Serial No.:

[ ] Executed concurrently with the execution of this instrument

WHEREAS, JNC CORPORATION

of 2-1, Otemachi 2-chome, Chiyoda-ku, Tokyo 1008105 Japan

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and Improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

Fourth Joint Inventor: Hideki HAYASHI

# **ASSIGNMENT CONTINUED**

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Koichi Shibata	Date: Tul 7, 2020
Sole or First Joint Inventor: Koichi SHIBATA	
Signature: 佐藤族治	Date: Jul 7, 2020
Second Joint Inventor: Teizi SATOU	
Signature: ## ###	Date: Jul 7, 2020
Third Joint Inventor: Daisuke INOKI	
Signature:	Date: Jul 7-2-20